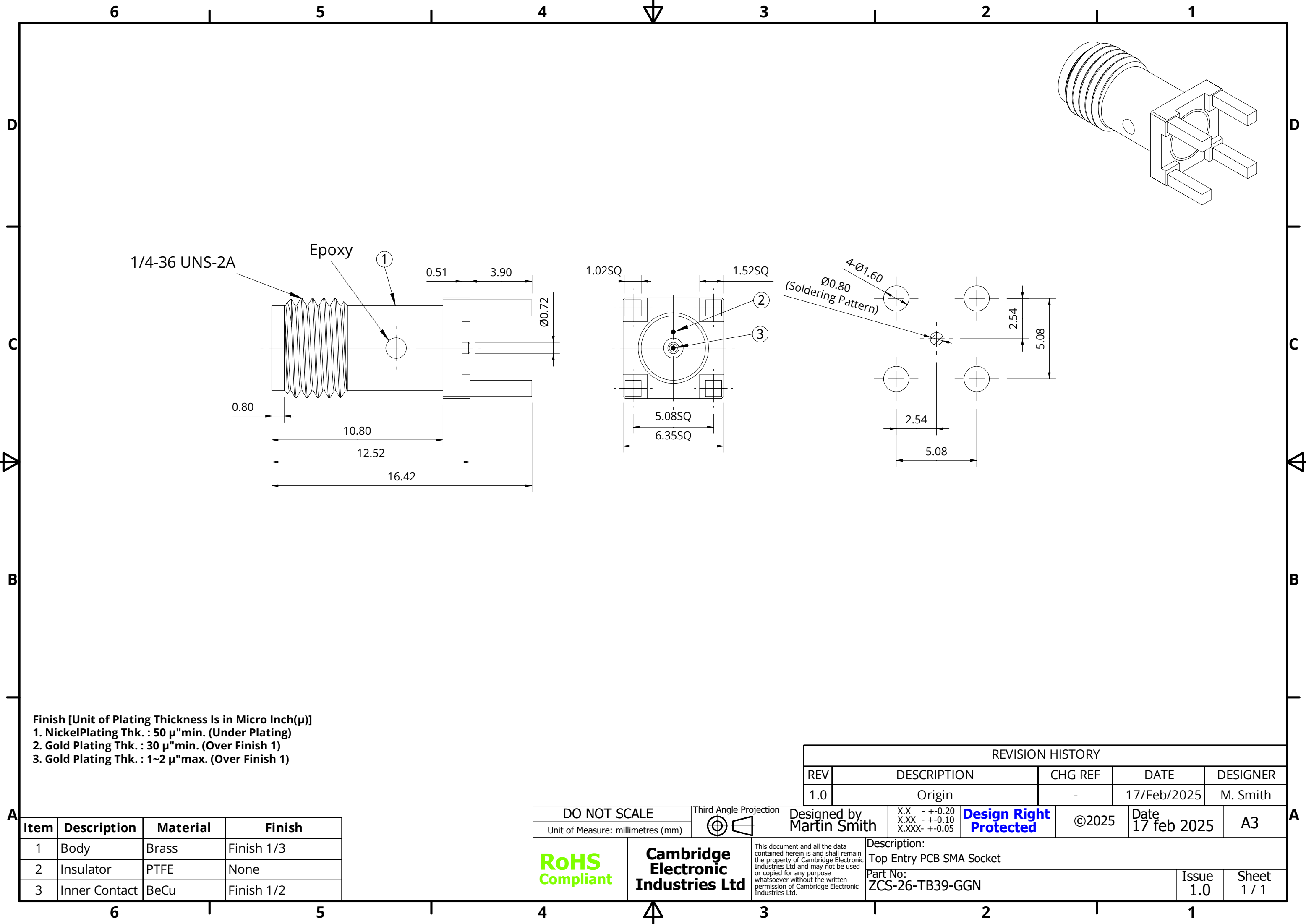




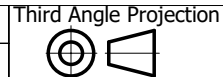
Finish [Unit of Plating Thickness Is in Micro Inch(μ)]

- 1. NickelPlating Thk. : 50 μ"min. (Under Plating)
- 2. Gold Plating Thk. : 30 μ"min. (Over Finish 1)
- 3. Gold Plating Thk. : 1~2 μ"max. (Over Finish 1)

Item	Description	Material	Finish
1	Body	Brass	Finish 1/3
2	Insulator	PTFE	None
3	Inner Contact	BeCu	Finish 1/2

DO NOT SCALE

Unit of Measure: millimetres (mm)



Designed by
Martin Smith

X.X - +0.20
X.XX - +0.10
X.XXX - +0.05

Design Right
Protected

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Date
17 feb 2025

A3

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Description:
Top Entry PCB SMA Socket

Part No:
ZCS-26-TB39-GGN

Issue
1.0

Sheet
1 / 1

REVISION HISTORY				
REV	DESCRIPTION	CHG REF	DATE	DESIGNER
1.0	Origin	-	17/Feb/2025	M. Smith